



PATENT

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of)	
Patel et al.) For:	IDENTIFYING PROCESS AND TEMPERATURE OF SILICON
))	CHIPS
Serial No. 10/750,342)	
Filed: December 31, 2003) Group No.	2857

SECOND REQUEST FOR CORRECTION OF OFFICIAL FILING RECEIPT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Attn: OFFICE OF INITIAL PATENT EXAMINATION'S CUSTOMER SERVICE CENTER

Dear Sir:

Applicant hereby submits a copy of the Request for Correction of Official Filing Receipt previously filed August 27, 2004, with attachments. Applicant received a response to our initial Request for Corrected Filling Receipt requesting that Applicant submit an amendment to the first page of the specification adding the claim to priority. No amendment to the first page of the specification should be necessary, as Applicant correctly claimed priority when the application was initially filed (please see attached copy of the first page of specification as originally filed.)

deposited with the United States Postal Servirst class mail in an envelope addressed	
Commissioner for Patents, P.O. Box Alexandria, VA 22313-1450, on:	
October 15, 2004	
(Date of Deposit)	
Theresa Badet	
(Name of the Person Making Deposit)	
News Gast	
(Signature)	

I hereby certify that this correspondence is being

Applicants submit that the above-indicated error is an error made on the part of the Office, rather than by the Applicants, and respectfully request that the noted error in the priority claim of the application be corrected and a new Official Filing Receipt be issued to Applicants.

Respectfully submitted,

Dated: October 15, 2004

Nicholas J. Pauley, Reg. No. 44,999 Phone No. (858) 845-8405

QUALCOMM Incorporated Attn: Patent Department 5775 Morehouse Drive

San Diego, California 92121-1714 Telephone: (858) 658-5787 Facsimile: (858) 658-2502

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Dear Sir:

Upon review of the Official Filing Receipt and Updated Filing Receipt, an error appears in the Domestic Priority data as claimed by applicant. Applicants request that this error be corrected and that a new Official Filing Receipt be issued.

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I hereby certify that this correspondence is being deposited with the United States Postal Service as

Enclosed herewith is a copy of the Combined Declaration/Power of Attorney filed on June 30, 2004. As listed on the Combined Declaration/Power of Attorney, the application claims priority to 60/525,103 filed November 24, 2003 AND 10/722,350 filed November 25, 2003.

Also enclosed, is a copy of the first page of patent application indicating the priority claim as well as a copy of the incorrect Official Filing Receipt showing the correction to me made in red ink.

Applicants submit that the above-indicated error is an error made on the part of the Office, rather than by the Applicants, and respectfully request that the noted error in the priority claim of the application be corrected and a new Official Filing Receipt be issued to Applicants.

Respectfully submitted,

Dated: August 27, 2004

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IDENTIFYING PROCESS AND TEMPERATURE OF SILICON CHIPS BACKGROUND

[0000] This application claims priority to U.S. Provisional Application Serial No. 60/525,103, filed November 24, 2003 and U.S. Application Serial No. 10/722,350, filed November 25, 2003.

Field

[0001] The present disclosure relates to systems and techniques for identifying process and temperature of chips.

Background

[0002] The demand for wireless services has led to the development of an ever increasing number of chips, all of which must adhere to strict industry performance standards. Manufacturing of silicon chips is guided in part by standards and tolerances for nominal process speed. Within the guidelines of such standards, chips are designed to run at their rated clock speed for their entire expected lifetime, even in worst-case temperature and voltage conditions. Thus, part of the manufacturing process includes testing manufactured chips to identify their rated clock speed and ensure they are rated properly.

[0003] Chips for use in communications devices must generally be rated to operate at a specified nominal speed, within a certain allowed tolerance. However, a set of chips generated from a single wafer commonly will fall into a range of different process speed ratings.

[0004] In an attempt to use those portions of the wafer that produce different speed ratings, some manufacturers engage in a method of speed binning, in which the various chips produced from a single wafer are tested and batched according to their graded process speed. Batching chips according to their speed may be time consuming and costly.

[0005] Some manufacturers may even discard slow chips and fast chips that are outside of the nominal tolerance range. For example, SDRAM chips require an external clock from the host controller with control and data signals. Because the host clock is sensitive to





COMBINED DECLARATION / POWER OF ATTORNEY

-	ic, i indicad i about ita i	HAT: This Declaration is of the	tonowing type.	
☐ Continuation	☐ Supplemental	☐ Continuation-In-☐ National Stage of		Divisional
My residence, post office address a one name is listed below) or an or which a patent is sought on the inv	iginal, first and joint invento	r (if plural names are listed below	w) of the subject matter	which is claimed and for
was amended on (if ag	003 as Serial No. 10/750,342 oplicable). a PCT International Applicat		l as amended under PCI	TArticle 19 on .
I hereby state that I have reviewed amendment referred to above. I accordance with Title 37, Code of I	acknowledge the duty to d	isclose information which is ma	cation, including the cla terial to the examination	ims, as amended by any on of this application in
I hereby claim foreign priority be certificate or of any PCT International have also identified below any for least one country other than the application(s) of which priority is considered.	onal application(s) designati eign application(s) for pater United States of America f	ng at least one country other than at or inventor's certificate or any	n the United States of A PCT International appl	merica listed below and ication(s) designating at
		· ·		
		•	Pr	iority Claimed
(Country)	(Application No.)	(Day/Month/Year/Filed		riority Claimed (No)
		. •	(Yes)	
(Country) I hereby claim the benefit under Tit		. •	(Yes)	
I hereby claim the benefit under Tit		ited States provisional application November 24, 2003	(Yes)	· · · · · · · · · · · · · · · · · · ·
I hereby claim the benefit under Tit		ited States provisional application	(Yes)	· · · · · · · · · · · · · · · · · · ·
I hereby claim the benefit under Tit		ited States provisional application November 24, 2003	(Yes)	
I hereby claim the benefit under Tit 60/525,103 (Serial No.)		ited States provisional application November 24, 2003 (Filing Date)	(Yes)	
I hereby claim the benefit under Tit 60/525,103 (Serial No.) 10/722,350	title 35 USC 120 of the Unite disclosed in the prior Unite disclose material informat	November 24, 2003 (Filing Date) November 25, 2003 (Filing Date) de States application(s) listed belied States application in the manifon as defined in Title 37 CFR 1.	(Yes) n(s) listed below: ow, and insofar as the soner provided by the first	(No) ubject matter of each of st paragraph of Title 35
I hereby claim the benefit under Tit 60/525,103 (Serial No.) 10/722,350 (Serial No.) I hereby claim the benefit under Tithe claims of this application is no USC 112, I acknowledge the duty to	title 35 USC 120 of the Unite disclosed in the prior Unite disclose material informat	November 24, 2003 (Filing Date) November 25, 2003 (Filing Date) de States application(s) listed belied States application in the manifon as defined in Title 37 CFR 1.	(Yes) n(s) listed below: ow, and insofar as the soner provided by the first	(No) ubject matter of each of st paragraph of Title 35

Attorney Docket No. 030439

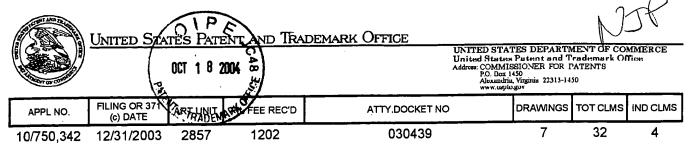
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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CONFIRMATION NO. 9469
UPDATED FILING RECEIPT
OC000000013412885

Date Mailed: 08/02/2004

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Jagrut Viliskumar Patel, San Diego, CA; Martin Vyungchon Choe, San Diego, CA; Ziad Mansour, Poway, CA;



Domestic Priority data as claimed by applicant

This appln claims benefit of 60/525,103 11/24/2003

10/722,350 11/25/2003

Foreign Applications

If Required, Foreign Filing License Granted: 05/03/2004

Projected Publication Date: 05/26/2005

Non-Publication Request: No

Early Publication Request: No

Title

Identifying process and temperature of silicon chips

RECEIVED - Patent Department

AUG 16

QUALCOMM Incorporator

Preliminary Class

702

LICENSE FOR FOREIGN FILING UNDER Title 35, United States Code, Section 184 Title 37, Code of Federal Regulations, 5.11 & 5.15

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